Hongxu Yang | Curriculum Vitae

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Summary

- Experienced researcher in machine learning, deep learning, signal/image processing
- First author of 10+ top international conference and journal publications in the field, and 2 patents
- Interdisciplinary collaborator with experiences in dataset collection, model design and deployment

Research Experience

Medical instrument detection in 3D US images

SPS-VCA, Eindhoven University of Technology/IBS, Philips Research

- Dec. 2016-Dec. 2020
- Initiated and developed deep learning-based instrument detection framework for cardiac catherization
- Conducted dataset collection on animal tissues and human patients for machine & deep learning
- Proposed novel methods for efficient and accurate 3D image segmentation
- Published papers in high impact conference and journal

Wearable Device and EEG-based authentication keys

SPS, Eindhoven University of Technology/IMEC Holst-Centre

Nov. 2015-Sep. 2016

- Developed an autoregressive-based and posterior probability encryption algorithm for biometric
- Published a paper on international conference

Education

Doctor of Philosophy, Artificial Intelligence, CS & EE

Eindhoven University of Technology, NL

Master of Science, Signal Processing, EE

Eindhoven University of Technology, NL

Bachelor of Engineering, EE

Tianjin University/Nankai University, CN

Eindhoven. Netherlands

Dec. 2016-Dec. 2020

Eindhoven, Netherlands

Sep. 2014-Nov. 2016

Tianjin, China

Sep. 2010-Jul. 2014

Software Skills

Python MatLab ROS

Image Processing libraries (Scikit-learn, Scikit-image, OpenCV...)

Al Frameworks (TensorFlow, PyTorch, Keras...)

R&D Skills

Data organization&collection&processing

Deep learning model deployment for ROS-based platform

Ph.D. Project topics

A real-time instrument detection method in 3D US

A detection algorithm based on ROS & Deep learning

Nov. 2018-Now.

3D catheter segmentation in Frustum ultrasound SPIE 2020 & looking for a journal	Jun. 2019–Sep. 2020
DNQ-driven semi-supervised learning to exploit unlabeled images MICCAI 2020 paper & IEEE TMI (major revision)	Nov. 2019–Jun. 2020
Efficient 3D image processing by hybrid dimension architecture IEEE T-BME & A Patent	Apr. 2019–Nov. 2019
A faster supervised learning-based medical instrument segmentation ICIP 2019 & ISBI 2019 & MICCAI 2019 & MedIA	Nov. 2018–Apr. 2019
A voxel-of-interest-based catheter segmentation method in 3D US ICIP 2018 & IJCARS & A Patent	April. 2018–Nov. 2018
Machine learning-based medical instrument detection & model-fitting SPIE MI 2018 & JMI	Dec. 2016–April. 2018

Patent Applications

- Object detection ultrasound system by dimension-hybrid method: Hongxu Yang, Alexander F Kolen, Caifeng Shan, Peter H.N. de With (filed in 2019)
- Identifying an interventional device in medical images: Hongxu Yang, Alexander F Kolen, Caifeng Shan, Peter H.N. de With (filed in 2018, published in 2020)

Selected Publication (first author)

- DQN-Driven Medical Instrument Segmentation in 3D US by Uncertainty-aware and Contextual Constrained Semi-Supervised Learning: *Major revision*
- Deep Q-Network-Driven Catheter Segmentation in 3D US by Hybrid Constrained Semi-Supervised Learning and Dual-UNet: MICCAI 2020 (oral)
- Efficient Medical Instrument Detection in 3D Volumetric Ultrasound Data: IEEE TBME 2020
- Efficient and Robust Instrument Segmentation in 3D Ultrasound Using Patch-of-Interest-FuseNet with Hybrid Loss: *MedIA* 2020
- Transferring from ex-vivo to in-vivo: Instrument Localization in 3D Cardiac Ultrasound Using Pyramid-UNet with Hybrid Loss: MICCAI 2019 (oral)
- Catheter localization in 3D ultrasound using voxel-of-interest-based ConvNets for cardiac intervention: IJCARS 2019

Services

Reviewer

MICCAI, IEEE JBHI, AE-CAI

Language

English (fluent) Chinese (native)

Reference

Available upon a request